



ON Semiconductor®

<http://onsemi.com>

3SK263

N-Channnel Dual Gate MOSFET 15V,30mA,PG=21dB,NF=1.1dB, CP4

Features

- Enhancement type
- Small noise figure
- Small cross modulation

Specifications

Absolute Maximum Ratings at Ta=25°C

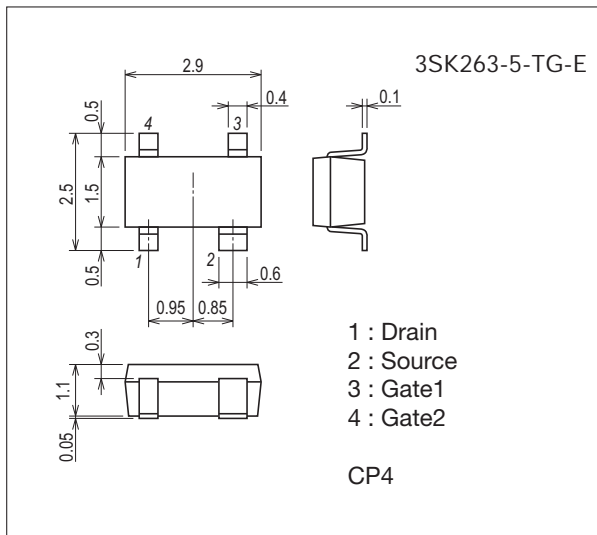
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DS}		15	V
Gate1-to-Source Voltage	V _{G1S}		±8	V
Gate2-to-Source Voltage	V _{G2S}		±8	V
Drain Current	I _D		30	mA
Allowable Power Dissipation	P _D		200	mW
Channel Temperature	T _{ch}		125	°C
Storage Temperature	T _{stg}		-55 to +125	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Package Dimensions

unit : mm (typ)

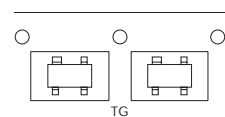
7014A-006



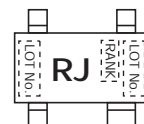
Product & Package Information

- Package : CP4
- JEITA, JEDEC : SC-61, SC-82AB, SOT-143, SOT-343
- Minimum Packing Quantity : 3,000 pcs./reel

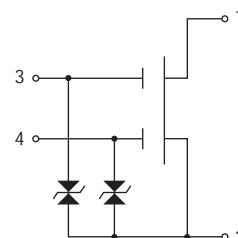
Packing Type: TG



Marking



Electrical Connection



3SK263

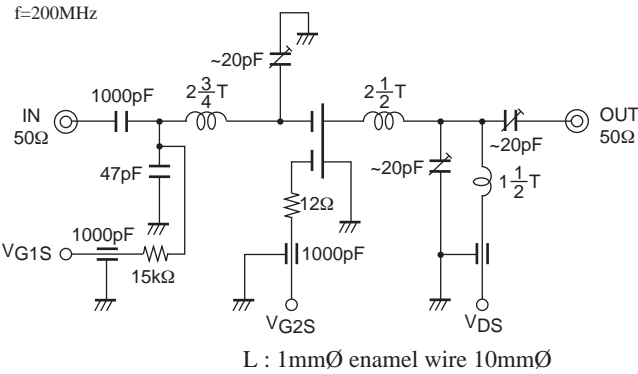
Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Voltage	V _{DS}	V _{G1S} =0V, V _{G2S} =0V, I _D =100μA	15			V
Gate1-to-Source Cutoff Voltage	V _{G1S} (off)	V _{DS} =6V, V _{G2S} =4V, I _D =100μA	0	0.7	1.3	V
Gate2-to-Source Cutoff Voltage	V _{G2S} (off)	V _{DS} =6V, V _{G1S} =3V, I _D =100μA	0.1	0.9	1.6	V
Gate1-to-Source Leakage Current	I _{G1SS}	V _{G1S} =±6V, V _{G2S} =V _{DS} =0V			±50	nA
Gate2-to-Source Leakage Current	I _{G2SS}	V _{G2S} =±6V, V _{G1S} =V _{DS} =0V			±50	nA
Zero-Gate Voltage Drain Current	I _{DSX}	V _{DS} =6V, V _{G1S} =1.5V, V _{G2S} =4V	2.5*		24*	mA
Forward Transfer Admittance	y _{fs}	V _{DS} =6V, I _D =10mA, V _{G2S} =4V, f=1kHz		14		mS
Input Capacitance	C _{iss}	V _{DS} =6V, f=1MHz, V _{G1S} =0V, V _{G2S} =4V		2.7		pF
Reverse Transfer Capacitance	C _{rss}			0.015	0.03	pF
Power Gain	PG	V _{DS} =6V, I _D =10mA, V _{G2S} =4V, f=200MHz	18	21		dB
Noise Figure	NF	V _{DS} =6V, I _D =10mA, V _{G2S} =4V, f=200MHz		1.1	2.2	dB

* : The 3SK263 is classified by I_{DSX} as follows : (unit : mA)

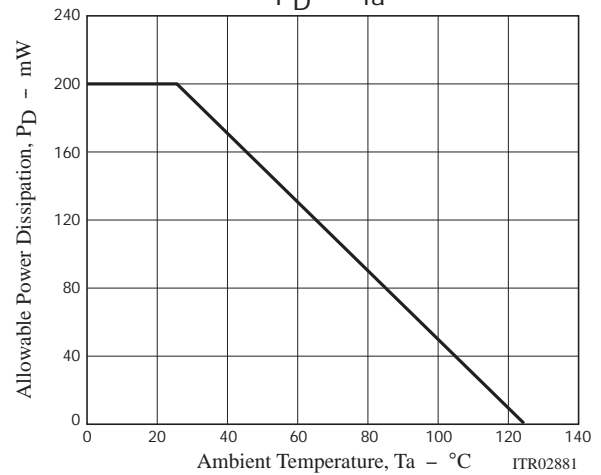
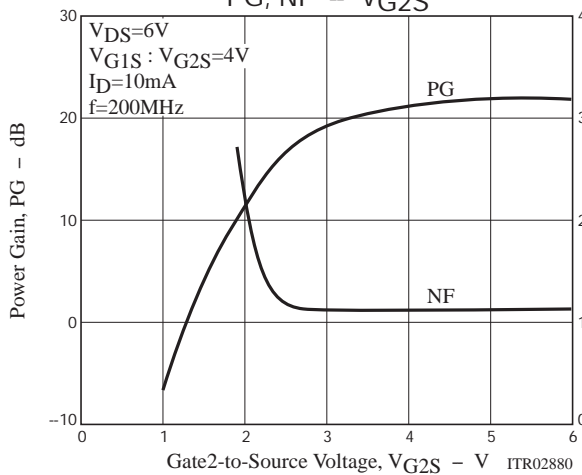
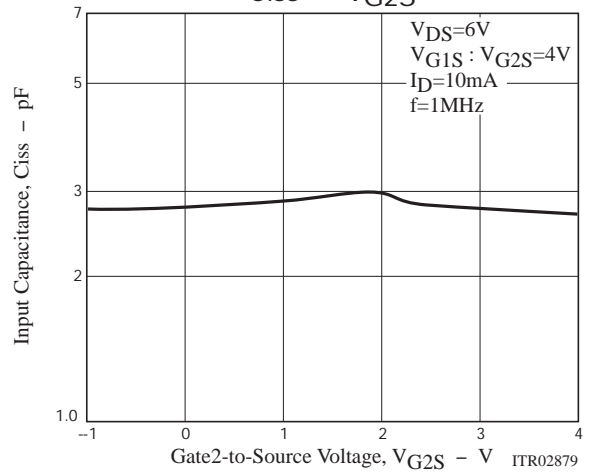
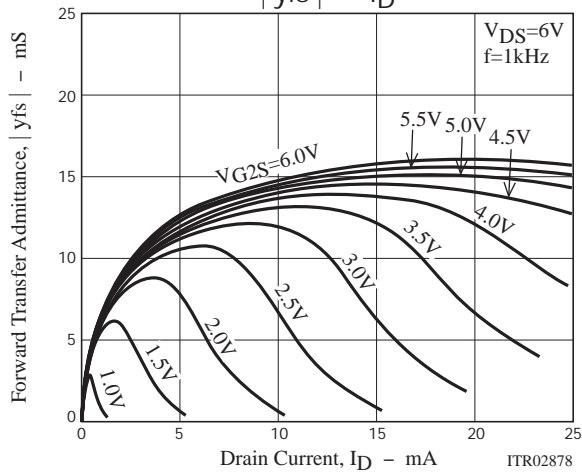
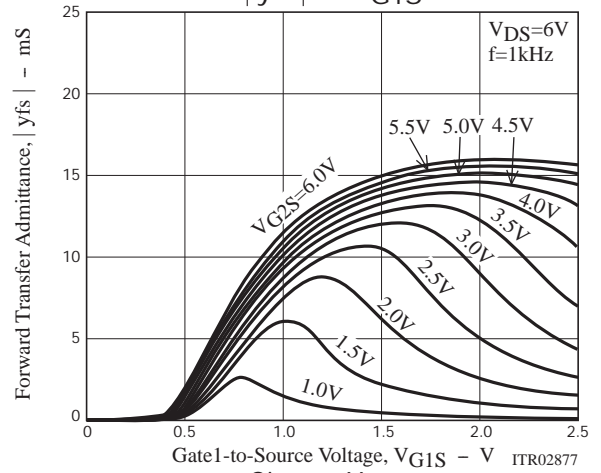
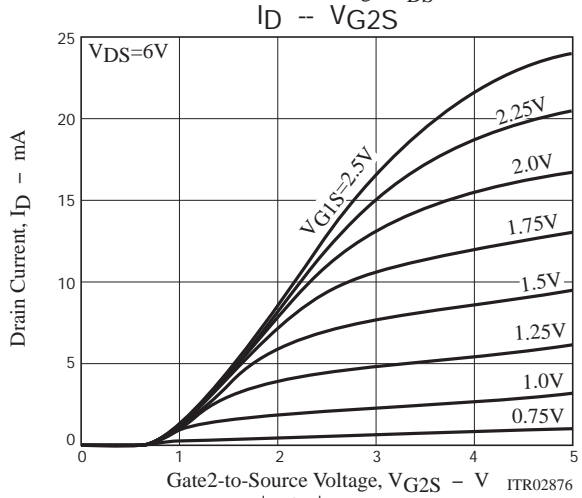
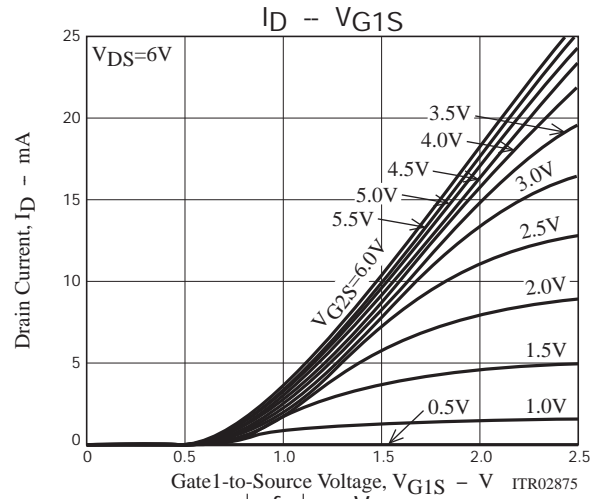
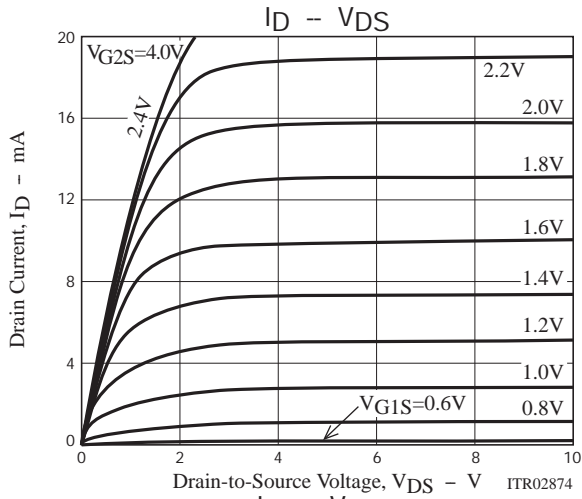
Rank	4	5	6
I _{DSX}	2.5 to 6.0	5.0 to 12.0	10.0 to 24.0

PG, NF Specified Test Circuit



Ordering Information

Device	Package	Shipping	memo
3SK263-5-TG-E	CP4	3,000pcs./reel	Pb Free



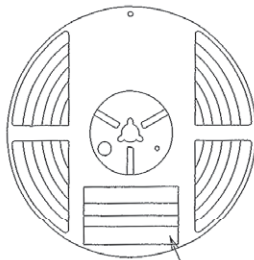
Embossed Taping Specification

3SK263-5-TG-E

Storage package Outline name	Carrier tape Type number	Maximum Number of devices contained (pcs.)			Packing format	
		Reel	Inner box	Outer box	Inner box BOX (C-1)	Outer box BOX (A-7)
CP4	CP4	3,000	15,000	90,000	5 reels contained Dimensions:mm(external) 1 8 3 × 7 2 × 1 8 5	6 inner boxes contained Dimensions:mm(external) 4 4 0 × 1 9 5 × 2 1 0

1. Packing format

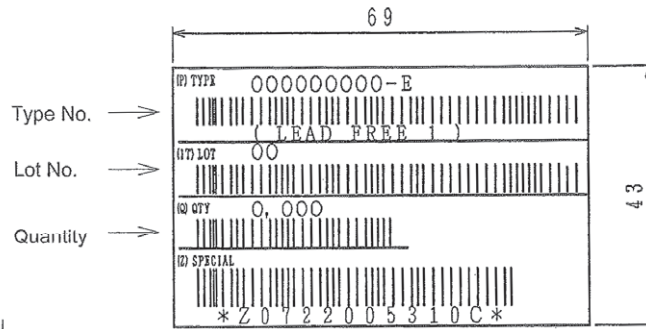
Packing method



Bar code label

Bar code label (Example)

(Unit : mm)

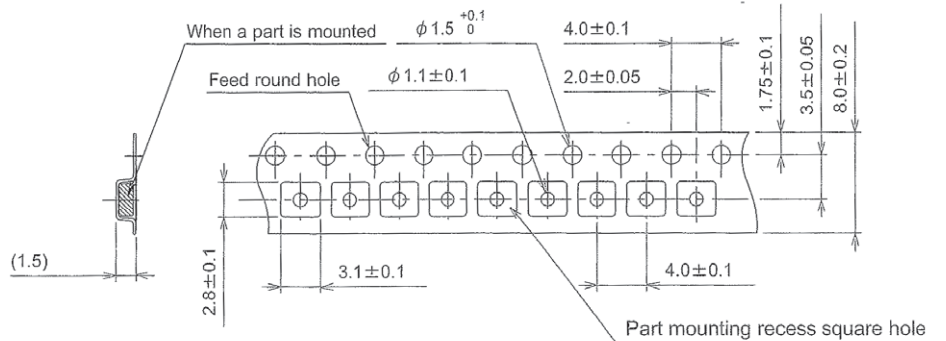


* LEAD FREE 1 :

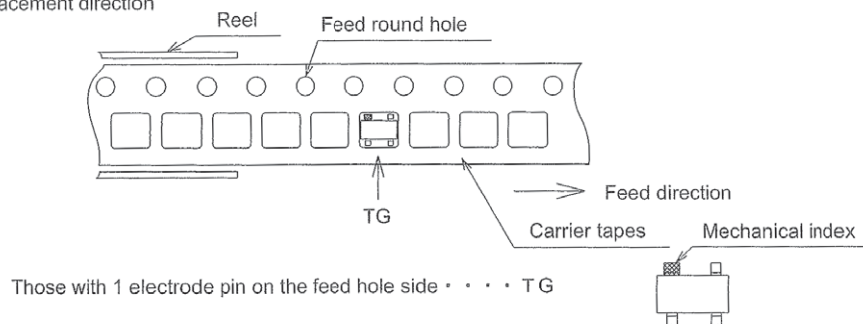
Lead-free External terminal surface
treatment product.

2. Taping structure

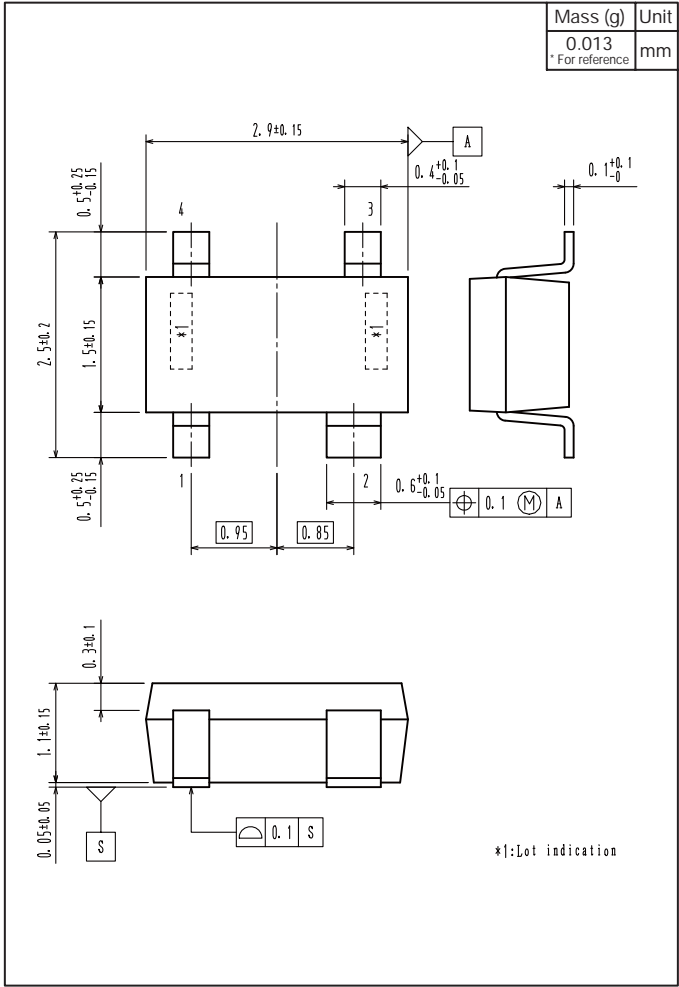
2-1. Carrier tape size (Unit : mm)



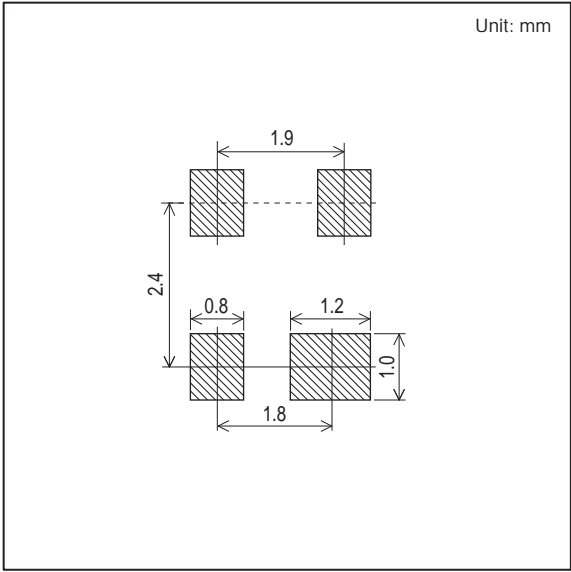
2-2. Parts placement direction



Outline Drawing
3SK263-5-TG-E



Land Pattern Example



ON Semiconductor and the ON logo are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.